Photocouplers Photorelay

TLP220AF

1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Instruments
- Factory Automation (FA)
- Amusement Equipment
- Smart Meters
- **Electricity Meters**

2. General

The TLP220AF photorelay consists of a photo MOSFET optically coupled to an infrared LED. It is housed in a 4-pin DIP package. It provides an isolation voltage of 5000 Vrms, making it suitable for applications that require reinforced insulation.

3. Features

- (1)Normally open (1-Form-A)
- OFF-state output terminal voltage: 60 V (min) (2)
- Trigger LED current: 2 mA (max) (3)
- (4) ON-state current: 500 mA (max)
- ON-state resistance: 2Ω (max) (5)
- Isolation voltage: 5000 Vrms (min) (6)
- (7) Safety standards
 - UL-recognized: UL 1577, File No.E67349

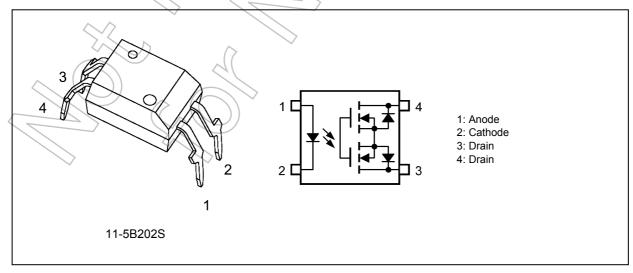
cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

VDE-approved: EN 60747-5-5 (Note 1)

CQC-approved: GB4943.1, GB8898 Japan Factory

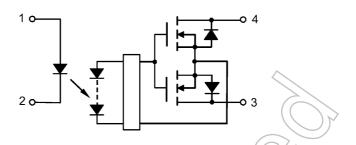
Note 1: When a VDE approved type is needed, please designate the Option (D4).

4. Packaging and Pin Assignment



Start of commercial production 2011-09 2019-11-21

5. Internal Circuit



6. Mechanical Parameters

Characteristics	7.62-mm Pitch TLP220A	10.16-mm Pitch TLP220AF	Unit
Creepage distances	7.0 (min)	8.0 (min)	mm
Clearance distances	7.0 (min)	8.0 (min)	\square
Internal isolation thickness	0.4 (min)	0.4 (min)	$(\vee))$

7. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25 °C$)

	Characteristics	Symbol	Note	Rating	Unit
LED	Input forward current	F()	$\langle \rangle$	30	mA
	Input forward current derating $(T_a \ge 25 \text{ °C})$	$\Delta I_F / \Delta T_a$))	-0.3	mA/°C
	Input forward current (pulsed) (100 µs pulse, 100 pps)	IFP		1	Α
	Input reverse voltage	VR		5	V
	Input power dissipation	Pp		50	mW
	Input power dissipation derating $(T_a \ge 25 \text{ °C})$	$\Delta P_D / \Delta T_a$		-0.5	mW/°C
	Junction temperature	Тj		125	°C
Detector	OFF-state output terminal voltage	V _{OFF}		60	V
	ON-state current	I _{ON}		500	mA
	ON-state current derating $(T_a \ge 25 \text{ °C})$	$\Delta I_{ON} / \Delta T_a$		-5	mA/°C
	ON-state current (pulsed) (t = 100 ms, duty = 1/10)	I _{ONP}		1.5	Α
	Output power dissipation	Po		500	mW
	Output power dissipation derating $(T_a \ge 25 \text{ °C})$	$\Delta P_0 / \Delta T_a$		-5.0	mW/°C
	Junction temperature	Tj		125	°C
Common	Storage temperature	T _{stg}		-55 to 125	°C
	Operating temperature	T _{opr}		-40 to 85	°C
\sim	Lead soldering temperature (10 s)	T _{sol}		260	°C
	Isolation voltage $(AC, 60 \text{ s}, \text{R.H.} \le 60 \text{ \%})$	BV _S	(Note 1)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

8. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V _{DD}		_	—	48	V
Input forward current	١ _F		3	5	15	mA
ON-state current	I _{ON}		2	—	500	
Operating temperature	T _{opr}		-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

9. Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.45	1.63	1.75	V
	Input reverse current	I _R		V _R = 5 V	_	A	10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	- /	40		pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 60 V	, –((D+a	1	μA
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz	X	(130)	/ _	pF

10. Coupled Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	(I _{ON} = 500 mA)) _	0.3	2	mA
Return LED current	I _{FC}	4	I _{OFF} = 10 μA	0.1	_	_	mA
ON-state resistance	R _{ON}	(Note 1)	$I_{ON} = 500 \text{ mA}, I_F = 5 \text{ mA}, \text{ Continuous}$	_	0.6	2	Ω

Note 1: Thermally saturated state.

11. Isolation Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	(Note 1)	V _{\$} = 500 V, R.H. ≤ 60 %	10 ¹²	1014	—	Ω
Isolation voltage	BVs	(Note 1)	AC, 60 s	5000	_		Vrms

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

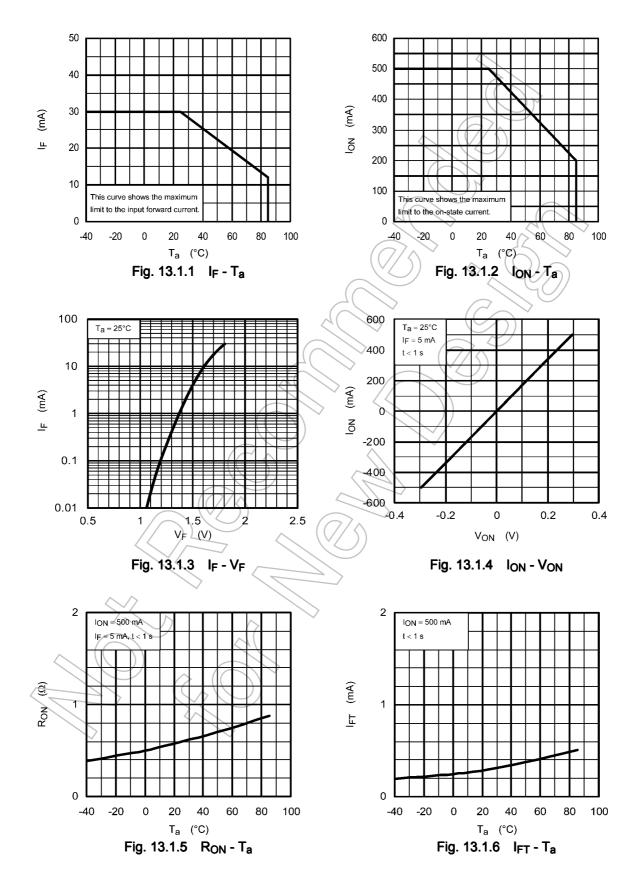
12. Switching Characteristics (Unless otherwise specified, $T_a = 25$ °C)

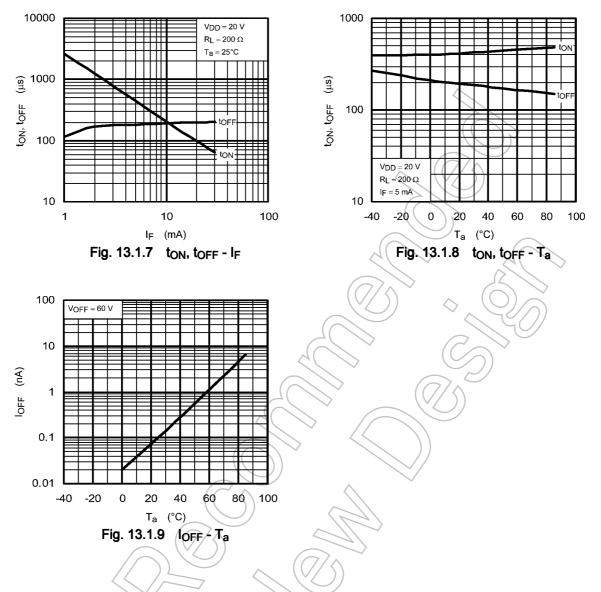
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Turn-on time	ton	See Fig. 12.1.	—	0.5	1	ms
Turn-off time	toff	R_L = 200 Ω, V_{DD} = 20 V, I_F = 5 mA	_	0.2	1	
			10 %		0 % FF	

Fig. 12.1 Switching Time Test Circuit and Waveform

13. Characteristics Curves

13.1. Characteristics Curves (Note)





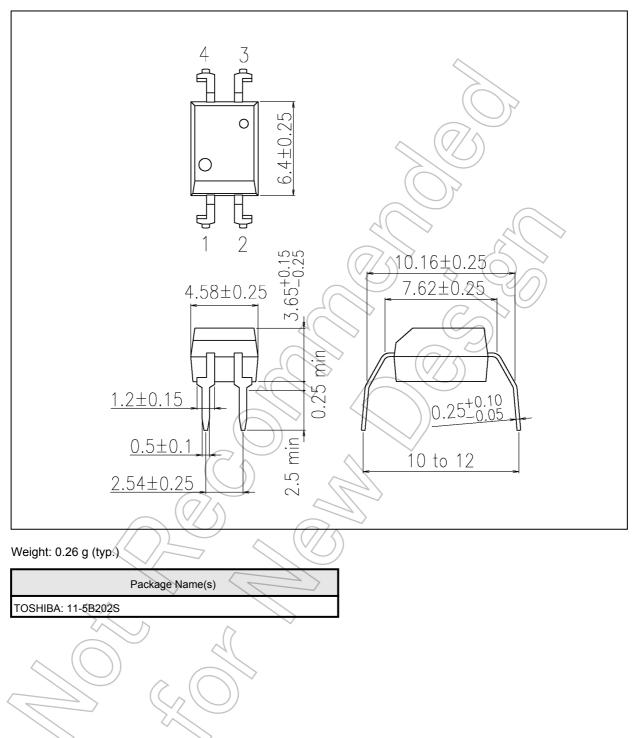
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

TLP220AF

Unit: mm



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